PHOTOTRANSISTOR



Features

Narrow angular response Durable High reliability in demanding environments

Application

Optical switches Optical detectors Infrared sensors Encoders Smoke detectors

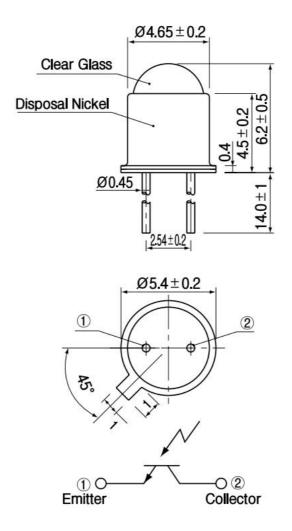
Description

The KST-1KL3A is a high-sensitivity NPN silicon phototransistors mounted in durable, hermetically sealed TO-18 metal can which provide years of reliable performance, even under demanding conditions such as use outdoors.





PACKAGE DIMENSIONS



NOTES:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm(.010") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.

PHOTOTRANSISTOR KST-1KL3A



MAXIMUM RATINGS

MAXIMUM RATINGS (Ta=25°C)							
Item	Symbol	Rating	Unit				
C-E voltage	Vceo	40	V				
E-C voltage	Veco	6	V				
Collector current	c	50	mA				
Collector power dissipation	Pc	150	mW				
Operating temp.	Topr.	-30~+100	°C				
Storage Temp.	Tstg.	-50~+150	°C				
Soldering temp. *1	Tsol.	260	°C				

*1. For MAX.5 seconds at the position of 2 mm from the package

ELECTRO-OPTICAL CHARACTERISTICS

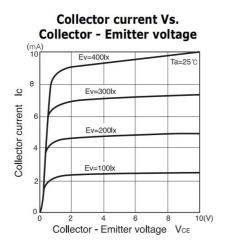
(Ta=25°C)

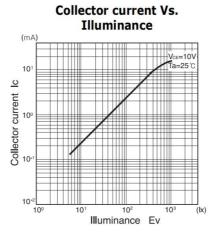
Item	ו	Symbol	Conditions	Min.	Тур.	Max.	Unit.
Collector dark curr	ent	CEO	$V_{CEO} = 10V$		1	200	nA
Light current		L	VCE = 10V, 2001x *2	1.5	5.0	15	mA
C-E saturation vol	tage	VCE(sat)	lc=5mA, 2,000lx *2		0.2	0.4	V
Switching speeds	Rise time	tr	Vcc=10V, $Ic=5mA$,		3.2		µsec.
	Fall time	tf	$R_{L}=100\Omega$		4.8		µsec.
Spectral sensitivity	ral sensitivity λ 500~1,050		nm				
Peak wavelength		λр			880		nm
Half anglee		Δθ			± 8		deg.

*2. Color temp.=2856K standard Tungsten lamp

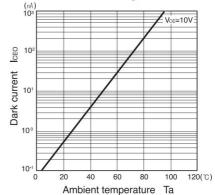
PHOTOTRANSISTOR KST-1KL3A

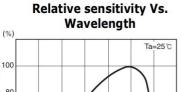


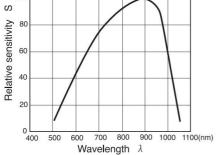


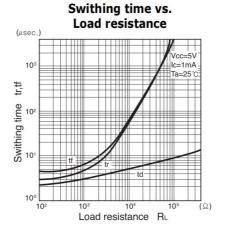


Dark current Vs. **Ambient temperature**



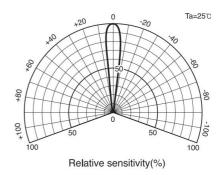


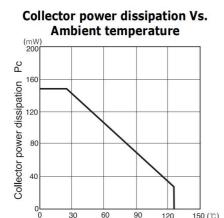




Radiant Pattern







60

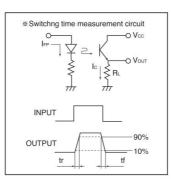
Ambient temperature Ta

30

90

120

150 (°C)



© 2019 SIVAGO SEMICONDUCTOR CO., LTD ALL RIGHTS RESERVED. www.sivago.com.cn sivago@sivago.com.cn

PHOTOTRANSISTOR



Packing Quantity Specification

- 1. 500Pcs/1Bag,20 Bag/1Box
- 2. 4Boxes/1Carton

Label Form Specification



- · PRODUCT: Part Number
- · CODE NO.: Product Serial Number
- · QTY: Packing Quantity
- · LOT No: Lot Number
- · REMARKS:Remarks

Notes Lead Forming

1. During lead frame bending, the lead frame should be bent at a distance more than 3mm from bottom of the epoxy.

Note: Must fix lead frame and do not touch epoxy before bending to avoid Phototransistors broken.

2.Lead forming should be done before soldering.

3. Avoid stressing the Phototransistor package during leads forming. The stress to the base may damage the Phototransistor's characteristics or it may break the Phototransistors.

4.Cut the Phototransistor lead frame at room temperature. Cutting the lead frame at high temperatures may cause failure of the Phototransistors.

5. When mounting the Phototransistors onto a PCB, the PCB holes must be aligned exactly with the lead position of the Phototransistor. If the Phototransistors are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the Phototransistors.

PHOTOTRANSISTOR



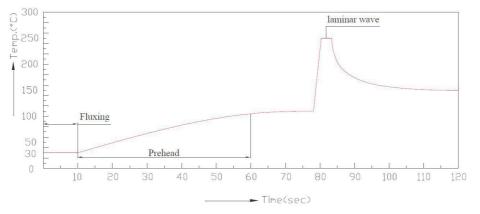
Soldering

1. Careful attention should be paid during soldering. When soldering, leave more than 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.

2. Recommended soldering conditions:

Hand	d Soldering	DIP Soldering		
Temp. at tip of iron	300°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max	
	3mm Min.(From solder		3mm Min. (From solder joint	
Distance	joint to epoxy bulb)	Distance	to epoxy bulb)	

3. Recommended soldering profile



4. Avoiding applying any stress to the lead frame while the Phototransistors are at high temperature particularly when soldering.

5. Dip and hand soldering should not be done more than one time

6.After soldering the Phototransistors, the epoxy bulb should be protected from mechanical shock or vibration until the Phototransistors return to room temperature.

7.A rapid-rate process is not recommended for cooling the Phototransistors down from the peak temperature.

8. Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the Phototransistors.

9. Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.



Legal Disclaimer Notice

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

SIVAGO SEMICONDUCTOR CO.,LTD its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "SIVAGO"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

SIVAGO makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, SIVAGO disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on SIVAGO's knowledge of typical requirements that are often placed on SIVAGO products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application.Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify SIVAGO's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, SIVAGO products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the SIVAGO product could result in personal injury or death.Customers using or selling SIVAGO products not expressly indicated for use in such applications do so at their own risk.Please contact authorized SIVAGO personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of SIVAGO. Product names and markings noted herein may be trademarks of their respective owners.